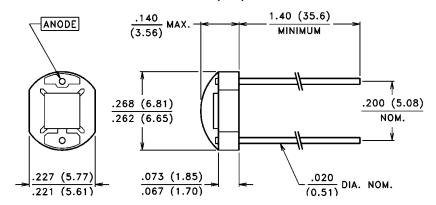


PACKAGE DIMENSIONS inch (mm)



CASE 11 CERAMIC
CHIP ACTIVE AREA: .012 in² (7.45 mm²)

PRODUCT DESCRIPTION

Planar silicon photodiode mounted on a two lead ceramic substrate and coated with a thick layer of clear epoxy. These diodes exhibit low dark current under reverse bias and fast speed of response.

ABSOLUTE MAXIMUM RATINGS

Storage Temperature: -20°C to 75°C

Operating Temperature: -20°C to 75°C

RoHS Compliant



ELECTRO-OPTICAL CHARACTERISTICS @ 25°C (See also VTP curves, pages 45-46)

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	VTP8350H			LINITO
			Min.	Тур.	Max.	- UNITS
I _{SC}	Short Circuit Current	H = 100 fc, 2850 K	65	80		μΑ
TC I _{SC}	I _{SC} Temperature Coefficient	2850 K		.20		%/°C
V _{OC}	Open Circuit Voltage	H = 100 fc, 2850 K		350		mV
TC V _{OC}	V _{OC} Temperature Coefficient	2850 K		-2.0		mV/°C
I _D	Dark Current	H = 0, VR = 10 V			30	nA
R _{SH}	Shunt Resistance	H = 0, V = 10 mV		100		GΩ
CJ	Junction Capacitance	H = 0, V = 3 V			50	pF
Re	Responsivity	940 nm		.06		A/(W/cm ²)
S _R	Sensitivity	@ Peak		.55		A/W
λ_{range}	Spectral Application Range		400		1150	nm
λ_{p}	Spectral Response - Peak			925		nm
V_{BR}	Breakdown Voltage		33	140		V
θ _{1/2}	Angular Resp 50% Resp. Pt.			±60		Degrees
NEP	Noise Equivalent Power		1.8 x 10 ⁻¹³ (Typ.)			W/√Hz
D*	Specific Detectivity		1.5 x 10 ¹² (Typ.)			cm√Hz/W